

Ordering Information

| Part Number | Marking | Package | Packing Method |
|-------------|---------|---------|----------------|
| FJB5555TM | J5555 | D2-PAK | Tape & Reel |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

| Symbol | Parameter | Value | Units |
|-------------------|------------------------------------|--------------|-------|
| BV _{CBO} | Collector-Base Voltage | 1050 | V |
| BV _{CEO} | Collector-Emitter Voltage 400 | | |
| BV _{EBO} | Emitter-Base Voltage | 14 | V |
| ۱ _C | Collector Current (DC) | 5 | A |
| I _{CP} | Collector Current (Pulse) | 10 | A |
| ۱ _B | Base Current (DC) | 2 | A |
| I _{BP} | Base Current (Pulse) | 4 | А |
| ТJ | Junction Temperature | 150 | °C |
| T _{STG} | Storage Junction Temperature Range | - 55 to +150 | °C |

Thermal Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | | Value | Units |
|-----------------------|---|---------------------------------|-------|-------|
| PD | Total Device Dissipation | T _A = 25°C | 1.6 | W |
| | | $T_{\rm C} = 25^{\circ}{\rm C}$ | 100 | W |
| $R_{\theta ja}^{(1)}$ | Thermal Resistance, Junction to Ambient | | 77.75 | °C/W |
| $R_{\theta jc}^{(2)}$ | Thermal Resistance, Junction to Case | 1.25 | °C/W | |

Notes:

1. Device mounted on FR-4 PCB, board size= 101.5 mm x 114.5 mm.

2. $R_{\theta jc}$ test fixture under infinite cooling condition.

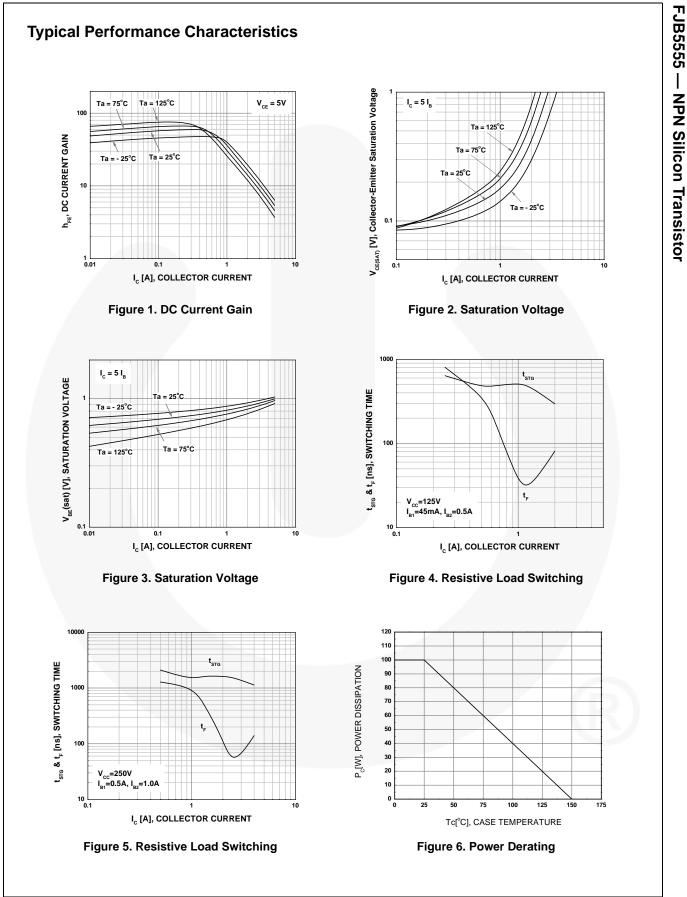
Electrical Characteristics⁽³⁾

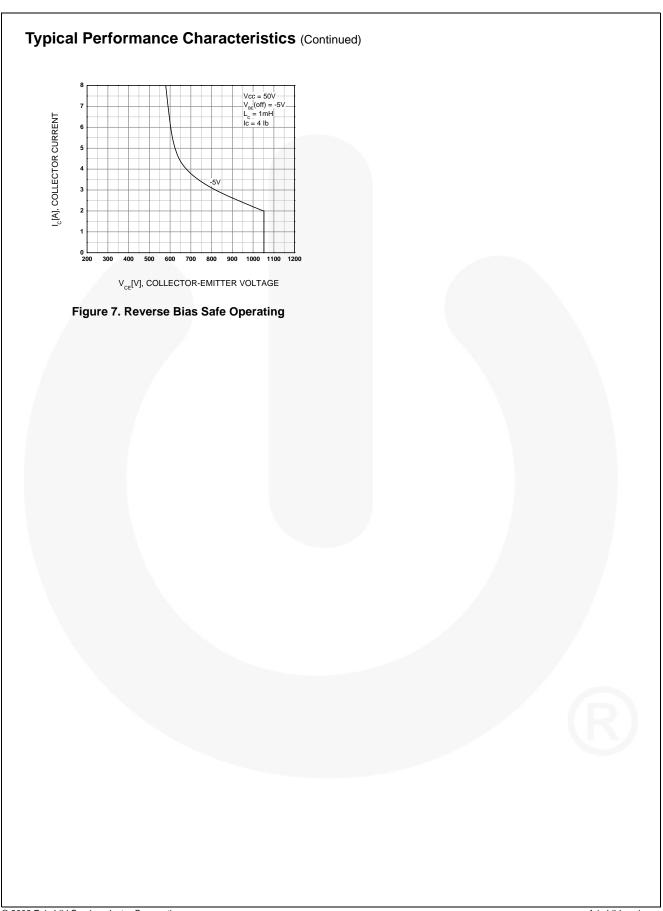
Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

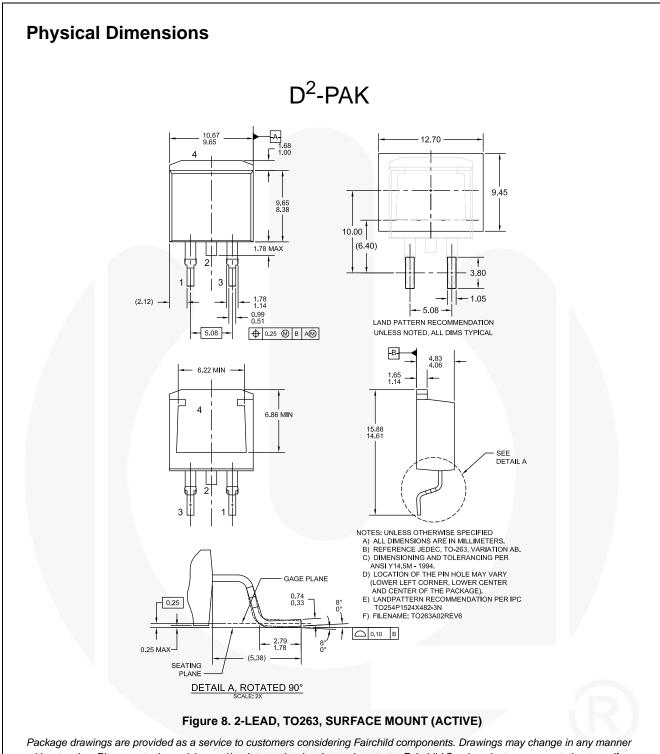
| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|-----------------------|--------------------------------------|--|------|------|------|-------|
| BV _{CBO} | Collector-Base Breakdown Voltage | I _C = 500 μA, I _E = 0 | 1050 | | | V |
| BV _{CEO} | Collector-Emitter Breakdown Voltage | $I_{C} = 5 \text{ mA}, I_{B} = 0$ | 400 | | | V |
| BV_{EBO} | Emitter-Base Breakdown Voltage | I _E = 500 μA, I _C = 0 | 14 | | | V |
| h _{FE} | DC Current Gain | $V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$ | 10 | | | |
| | | $V_{CE} = 3 \text{ V}, \text{ I}_{C} = 0.8 \text{ A}$ | 20 | | 40 | |
| V _{CE} (sat) | Collector-Emitter Saturation Voltage | $I_{\rm C} = 1 \text{ A}, I_{\rm B} = 0.2 \text{ A}$ | | 0.17 | 0.50 | V |
| | | I _C = 3.5 A, I _B = 1.0 A | | | 1.5 | V |
| V _{BE} (sat) | Base-Emitter Saturation Voltage | I _C = 3.5 A, I _B = 1.0 A | | | 1.2 | V |
| C _{ob} | Output Capacitance | V _{CB} = 10 V, f = 1 MHz | | 45 | | pF |
| t _{ON} | Turn-On Time | $V_{CC} = 125 \text{ V}, I_{C} = 0.5 \text{ A},$ | | | 1.0 | μs |
| t _{STG} | Storage Time | $I_{B1} = 45 \text{ mA}, I_{B2} = -0.5 \text{ A},$ $R_{L} = 250 \Omega$ | | | 1.2 | μs |
| t _F | Fall Time | | | 0.3 | | μs |
| t _{ON} | Turn-On Time | $V_{CC} = 250 \text{ V}, \text{ I}_{C} = 2.5 \text{ A}, \\ I_{B1} = 0.5 \text{ A}, \text{ I}_{B2} = -1.0 \text{ A}, \\ R_{L} = 100 \Omega$ | | | 2.0 | μs |
| t _{STG} | Storage Time | | | | 2.5 | μs |
| t _F | Fall Time | | | | 0.3 | μs |
| EAS | Avalanche Energy | L = 2 mH | 6 | | | mJ |

Note:

3. Pulse test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2%.







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FJB5555 — NPN Silicon Transistor

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| Datasheet Identification | Product Status | Definition |
|--------------------------|-----------------------|--|
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| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
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| | | Rev. 164 |



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